Dual 40 V, 6.0 A, Low V_{CE(sat)} PNP Transistor

ON Semiconductor's e^2 PowerEdge family of low $V_{CE(sat)}$ transistors are surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- Halide Free
- This is a Pb-Free Device

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

| Rating | Symbol | Max | Unit |
|--------------------------------|------------------|----------------------------|------|
| Collector-Emitter Voltage | V _{CEO} | -40 | Vdc |
| Collector-Base Voltage | V_{CBO} | -40 | Vdc |
| Emitter-Base Voltage | V_{EBO} | -7.0 | Vdc |
| Collector Current - Continuous | I _C | -3.0 | Α |
| Collector Current - Peak | I _{CM} | -6.0 | Α |
| Electrostatic Discharge | ESD | HBM Class 3B MM Class C | |

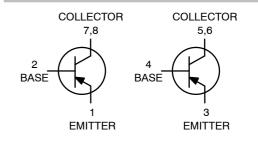
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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$\begin{array}{c} \text{40 VOLTS} \\ \text{6.0 AMPS} \\ \text{PNP LOW V}_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \text{EQUIVALENT R}_{\text{DS(on)}} \text{ 80 m} \Omega \end{array}$





SOIC-8 CASE 751 STYLE 16

DEVICE MARKING



40300 = Specific Device Code A = Assembly Location

Y = Year WW = Work Week • = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|---------------------|-----------------------|
| NSS40300DDR2G | SOIC-8 (Pb-Free) | 2500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|-----------------------------------|-------------|-------|
| SINGLE HEATED | | | |
| Total Device Dissipation (Note 1) | P _D | 576 | mW |
| T _A = 25°C Derate above 25°C | | 4.6 | mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 1) | $R_{	hetaJA}$ | 217 | °C/W |
| Total Device Dissipation (Note 2) | P _D | 676 | mW |
| T _A = 25°C Derate above 25°C | | 5.4 | mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{	hetaJA}$ | 185 | °C/W |
| DUAL HEATED (Note 3) | | | |
| Total Device Dissipation (Note 1) | P _D | 653 | mW |
| T _A = 25°C Derate above 25°C | | 5.2 | mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 1) | $R_{	heta JA}$ | 191 | °C/W |
| Total Device Dissipation (Note 2) | P _D | 783 | mW |
| T _A = 25°C Derate above 25°C | | 6.3 | mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{	hetaJA}$ | 160 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{sta} | -55 to +150 | °C |

FR-4 @ 10 mm², 1 oz. copper traces, still air.
 FR-4 @ 100 mm², 1 oz. copper traces, still air.
 Dual heated values assume total power is the sum of two equally powered devices.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------------------|--------------------------|--------------------------------------|--------------------------------------|------|
| OFF CHARACTERISTICS | • | | | | |
| Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mAdc}, I_B = 0)$ | V _{(BR)CEO} | -40 | - | - | Vdc |
| Collector – Base Breakdown Voltage (I _C = -0.1 mAdc, I _E = 0) | V _{(BR)CBO} | -40 | - | - | Vdc |
| Emitter – Base Breakdown Voltage $(I_E = -0.1 \text{ mAdc}, I_C = 0)$ | V _{(BR)EBO} | -7.0 | - | - | Vdc |
| Collector Cutoff Current (V _{CB} = -40 Vdc, I _E = 0) | I _{CBO} | - | - | -0.1 | μAdc |
| Emitter Cutoff Current (V _{EB} = -6.0 Vdc) | I _{EBO} | - | - | -0.1 | μAdc |
| ON CHARACTERISTICS | | | | | |
| DC Current Gain (Note 4) $ (I_{C} = -10 \text{ mA}, V_{CE} = -2.0 \text{ V}) $ $ (I_{C} = -500 \text{ mA}, V_{CE} = -2.0 \text{ V}) $ $ (I_{C} = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}) $ $ (I_{C} = -2.0 \text{ A}, V_{CE} = -2.0 \text{ V}) $ | h _{FE} | 250 220 180 150 | 380 340 300 230 | - - - | |
| Collector – Emitter Saturation Voltage (Note 4) $ \begin{aligned} &(I_C = -0.1 \text{ A, } I_B = -0.010 \text{ A}) \\ &(I_C = -1.0 \text{ A, } I_B = -0.100 \text{ A}) \\ &(I_C = -1.0 \text{ A, } I_B = -0.010 \text{ A}) \\ &(I_C = -2.0 \text{ A, } I_B = -0.200 \text{ A}) \end{aligned} $ | V _{CE(sat)} | - - - - | -0.013 -0.075 -0.130 -0.135 | -0.017 -0.095 -0.170 -0.170 | V |
| Base – Emitter Saturation Voltage (Note 4) $(I_C = -1.0 \text{ A}, I_B = -0.01 \text{ A})$ | V _{BE(sat)} | - | -0.780 | -0.900 | V |
| Base – Emitter Turn–on Voltage (Note 4) (I _C = -0.1 A, V _{CE} = -2.0 V) | V _{BE(on)} | - | -0.660 | -0.750 | V |
| Cutoff Frequency ($I_C = -100 \text{ mA}$, $V_{CE} = -5.0 \text{ V}$, $f = 100 \text{ MHz}$) | f _T | 100 | - | _ | MHz |
| Input Capacitance (V _{EB} = -0.5 V, f = 1.0 MHz) | Cibo | - | 250 | 300 | pF |
| Output Capacitance (V _{CB} = -3.0 V, f = 1.0 MHz) | Cobo | - | 50 | 65 | pF |
| SWITCHING CHARACTERISTICS | | | | | |
| Delay ($V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$) | t _d | - | - | 60 | ns |
| Rise ($V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$) | t _r | - | - | 120 | ns |
| Storage ($V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$) | t _s | - | - | 400 | ns |
| Fall ($V_{CC} = -30 \text{ V}$, $I_{C} = -750 \text{ mA}$, $I_{B1} = -15 \text{ mA}$) | t _f | - | - | 130 | ns |
| | | | | | |

^{4.} Pulsed Condition: Pulse Width = 300 μ sec, Duty Cycle \leq 2%.

TYPICAL CHARACTERISTICS

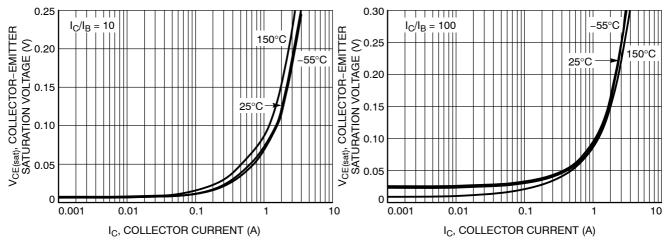


Figure 1. Collector Emitter Saturation Voltage vs. Collector Current

Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

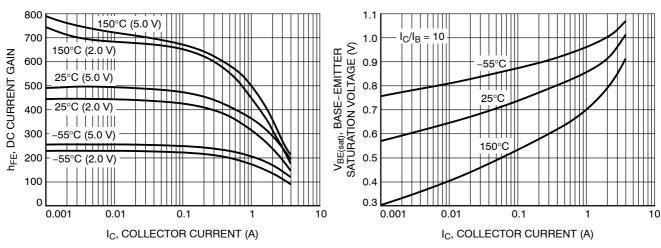


Figure 3. DC Current Gain vs. Collector Current

Figure 4. Base Emitter Saturation Voltage vs.
Collector Current

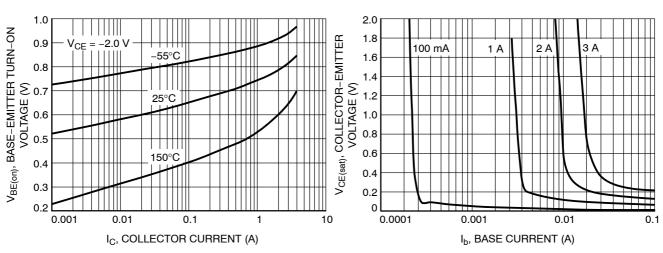


Figure 5. Base Emitter Turn-On Voltage vs.
Collector Current

Figure 6. Saturation Region

TYPICAL CHARACTERISTICS

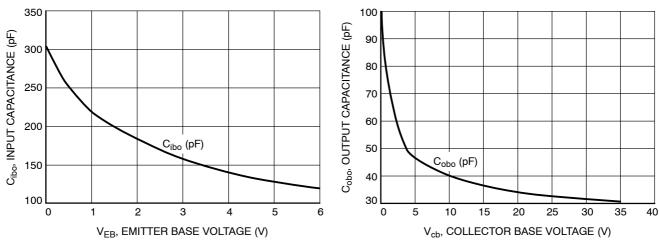


Figure 7. Input Capacitance

Figure 8. Output Capacitance

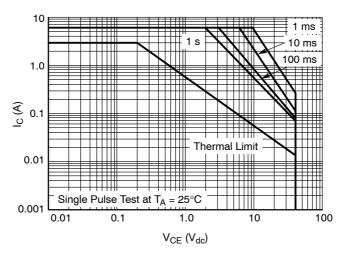
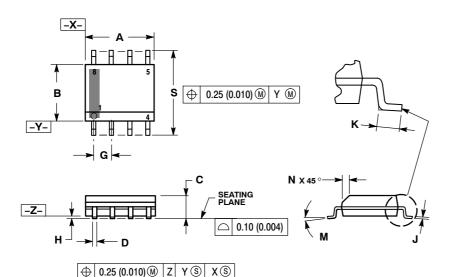


Figure 9. Safe Operating Area



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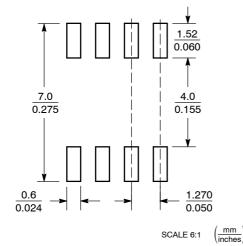


NOTES:

- DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A AND B DO NOT INCLUDE
- MOLD PROTRUSION
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

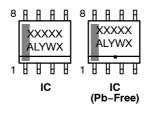
| | MILLIMETERS | | INC | HES |
|-----|-------------|------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 4.80 | 5.00 | 0.189 | 0.197 |
| В | 3.80 | 4.00 | 0.150 | 0.157 |
| С | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.33 | 0.51 | 0.013 | 0.020 |
| G | 1.27 BSC | | 0.05 | 0 BSC |
| Н | 0.10 | 0.25 | 0.004 | 0.010 |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.40 | 1.27 | 0.016 | 0.050 |
| М | 0 ° | 8 ° | 0 ° | 8 ° |
| N | 0.25 | 0.50 | 0.010 | 0.020 |
| s | 5.80 | 6.20 | 0.228 | 0.244 |

SOLDERING FOOTPRINT*



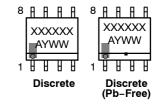
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location = Wafer Lot = Year

= Work Week = Pb-Free Package



XXXXXX = Specific Device Code Α = Assembly Location ww = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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|---|---|--|--|
| 2. N/C 3. REXT 4. GND 5. IOUT 6. IOUT 7. IOUT 8. IOUT STYLE 29: PIN 1. BASE, DIE #1 2. EMITTER, #1 3. BASE, #2 4. EMITTER, #2 5. COLLECTOR, #2 6. COLLECTOR, #2 7. COLLECTOR, #1 8. COLLECTOR, #1 | 2. dv/dt 3. ENABLE 4. ILIMIT 5. SOURCE 6. SOURCE 7. SOURCE 8. VCC STYLE 30: PIN 1. DRAIN 1 2. DRAIN 1 3. GATE 2 4. SOURCE 2 5. SOURCE 1/DRAIN 2 6. SOURCE 1/DRAIN 2 7. SOURCE 1/DRAIN 2 8. GATE 1 | 2. OVLO 3. UVLO 4. INPUT+ 5. SOURCE 6. SOURCE 7. SOURCE 8. DRAIN | 2. DASIC_OFF 3. DASIC_SW_DET 4. GND 5. V_MON 6. VBULK 7. VBULK 8. VIN |
| 6. COMMON ANODE 7. COMMON ANODE 8. CATHODE 6 STYLE 25: PIN 1. VIN | 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GNI STYLE 26: PIN 1. GND | 6. COMMON ANODE/GND 7. COMMON ANODE/GND 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT | 6. CATHODE 7. COLLECTOR/ANODE 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND |
| STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3. CATHODE 3 4. CATHODE 4 5. CATHODE 5 | STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/N 3. COMMON CATHODE/N 4. I/O LINE 3 5. COMMON ANODE/GNI | CC 3. COMMON ANODE/GND 4. LINE 2 IN | PIN 1. BASE 2. EMITTER 3. COLLECTOR/ANODE 4. COLLECTOR/ANODE 5. CATHODE |
| 4. TXE 5. RXE 6. VEE 7. GND 8. ACC | 4. GATE 5. DRAIN 6. DRAIN 7. CATHODE 8. CATHODE | 4. GATE 2 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. MIRROR 1 | 4. GATE (P) 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN STYLE 24: |
| STYLE 17: PIN 1. VCC 2. V2OUT 3. V1OUT | STYLE 18: PIN 1. ANODE 2. ANODE 3. SOURCE | STYLE 19: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 | STYLE 20: PIN 1. SOURCE (N) 2. GATE (N) 3. SOURCE (P) |
| 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN | 5. P-DRAIN 6. P-DRAIN 7. N-DRAIN 8. N-DRAIN | 5. CATHODE, COMMON 6. CATHODE, COMMON 7. CATHODE, COMMON 8. CATHODE, COMMON | 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 7. COLLECTOR, DIE #1 8. COLLECTOR, DIE #1 |
| STYLE 13: PIN 1. N.C. 2. SOURCE 3. SOURCE 4. GATE | STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3. P-SOURCE 4. P-GATE | STYLE 15: PIN 1. ANODE 1 2. ANODE 1 3. ANODE 1 4. ANODE 1 | STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2 4. BASE, DIE #2 |
| 2. COLLECTOR, DIE #1 3. COLLECTOR, DIE #2 4. EMITTER, COMMON 5. EMITTER, COMMON 6. BASE, DIE #2 7. BASE, DIE #1 8. EMITTER, COMMON | 2. BIAS 1 3. OUTPUT 4. GROUND 5. GROUND 6. BIAS 2 7. INPUT 8. GROUND | 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1 8. DRAIN 1 | 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN |
| 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON | 8. SOURCE STYLE 10: PIN 1. GROUND | 8. FIRST STAGE Vd STYLE 11: PIN 1. SOURCE 1 | 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE |
| STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN 4. DRAIN 5. GATE 6. GATE 7. SOURCE | STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN 4. SOURCE 5. SOURCE 6. GATE 7. GATE | STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS 3. THIRD STAGE SOURCE 4. GROUND 5. DRAIN 6. GATE 3 7. SECOND STAGE Vd | STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 3. BASE, #2 4. COLLECTOR, #2 5. COLLECTOR, #2 6. EMITTER, #1 2. COLLECTOR #1 |
| 3. COLLECTOR 4. EMITTER 5. EMITTER 6. BASE 7. BASE 8. EMITTER | 3. COLLECTOR, #2 4. COLLECTOR, #2 5. BASE, #2 6. EMITTER, #2 7. BASE, #1 8. EMITTER, #1 | 3. DRAIN, #2 4. DRAIN, #2 5. GATE, #2 6. SOURCE, #2 7. GATE, #1 8. SOURCE, #1 | ANODE ANODE ANODE ANODE ANODE ANODE COMMON CATHODE |
| COLLECTOR | PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 | 2. DRAIN, #1 | 2. ANODE |

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